

LIGHT EMITTING DIODE SPECIFICATION

DESCRIPTION: IE-3535UVC-275-XmW-CE
REVISION: V2.2
ISSUE DATE: 2022-05-03

**Features:**

- Long operating life
- Low Power Consumption
- Wide Viewing Angle
- RoHS Compliant
- Quartz Glass Lens

Application:

- Sterilization
- UV curing
- Bio-analysis/detection

Part Number	Dice Material	Emitted Color	Lens Color
IE-3535UVC-275-5mW-CE	InGaN	UVC	Water Clear

Electro-Optical Characteristics($T_a=25^{\circ}\text{C}$)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Radiation power	Φ_e	3	5	8	mW	IF=30mA
Forward Voltage	VF	5.5	6.0	7.0	v	
Dominant Wavelength	λ_d	270	275	280	nm	
Viewing Angle	$2\theta_{1/2}$	-	120	-	deg	
Reverse Current	IR	-	-	10	uA	VR=5V

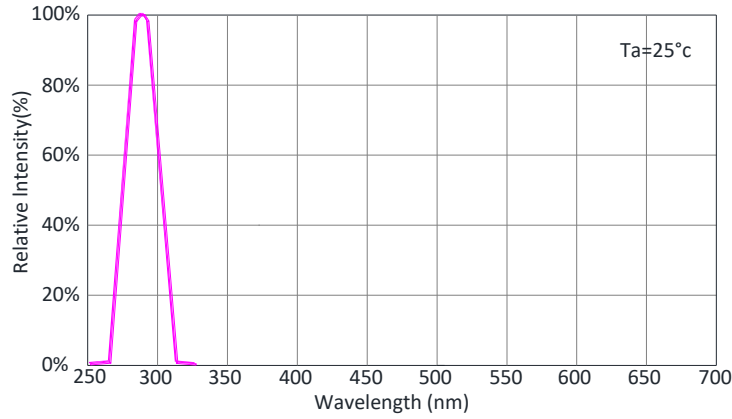
Absolute Maximum Ratings($T_a=25^{\circ}\text{C}$)

Parameter	Symbol	Max.	Unit
Peak Forward Current(1/10 Duty Cycle, 0.1ms Pulse Width)	IFP	80	mA
Forward Current	IF	40	mA
Reverse Voltage	VR	5	v
Operating Temperature Range	Topr	-40to+80	$^{\circ}\text{C}$
Storage Temperature Range	Tstg	-40to+85	$^{\circ}\text{C}$
Reflow Soldering	Tsld	260 $^{\circ}\text{C}$ for 10secs	

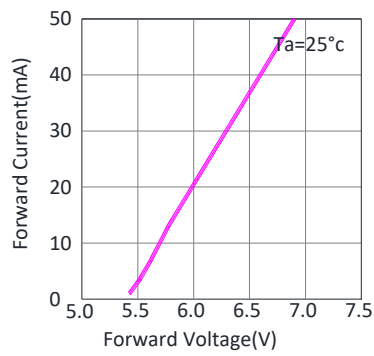
Optical & Electrical Characteristics

UVC

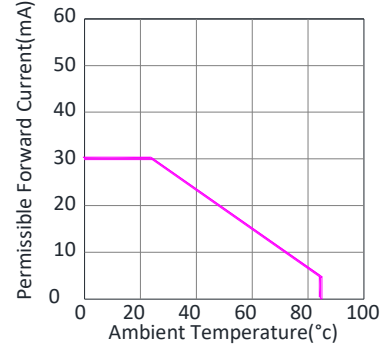
Relative Intensity vs. Wavelength



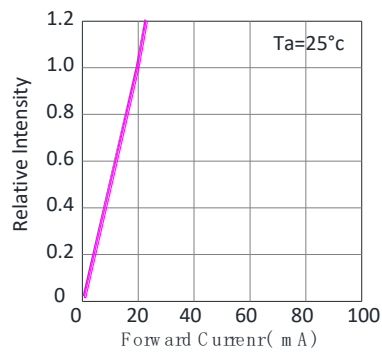
Forward Current vs. Forward Voltage



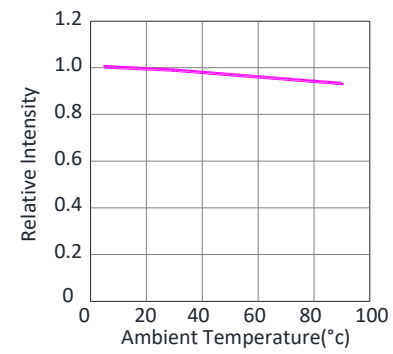
Forward Current vs. Ambient Temperature



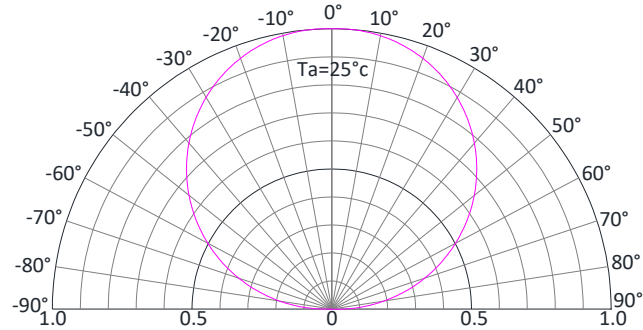
Relative Intensity vs. Forward Current



Relative Intensity vs. Ambient Temperature



Radiation Pattern



Bin Limits**Bin Range Of Radiant Intensity (Unit:mw)**

Bin Code	Min	Max	Condition
L1	3	5	IF=30mA
L2	5	8	
L3	-	-	

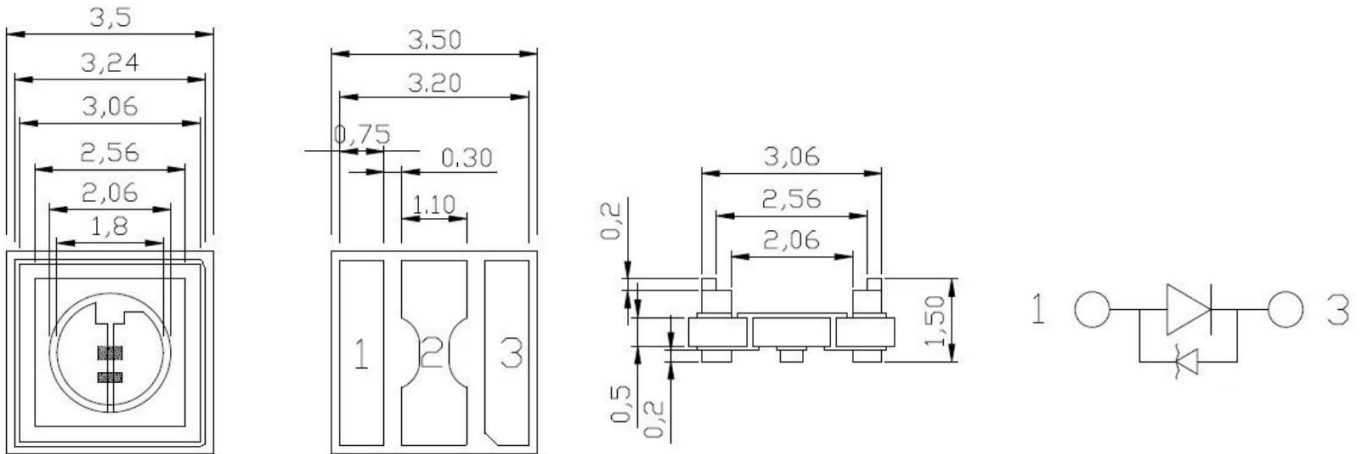
Bin Range Of Forward Voltage (Unit:V)

Bin Code	Min	Max	Condition
V1	5.5	6.0	IF=30mA
V2	6.0	6.5	
V3	6.5	7.0	
V4	-	-	
V5	--	-	

Notes:

- 1.Tolerance of Luminous Intensity $\pm 10\%$
- 2.Tolerance of Forward Voltage $\pm 0.1V$

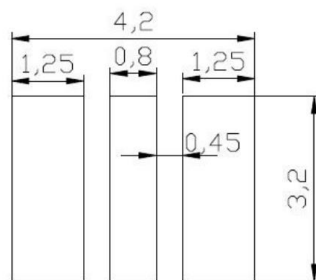
Product size (Unit:mm)



NOTES :

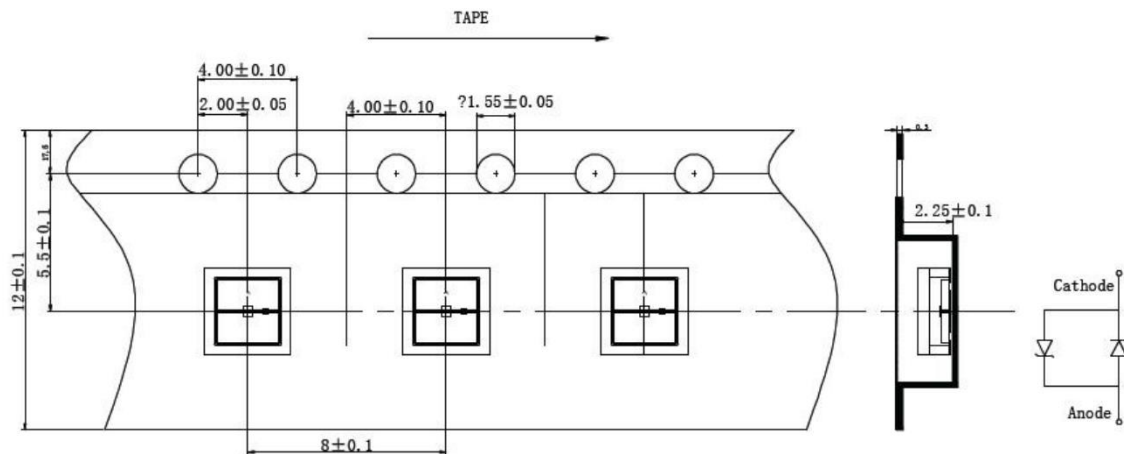
1. All dimensions are in millimeters (inches)
2. Tolerances are $\pm 0.2\text{mm}$ (0.008inch) unless otherwise noted

Recommended Soldering Pad Design (Unit:mm)



Taping and package Spec

- Tape Specification: 1,000pcs Per Reel



Packaging

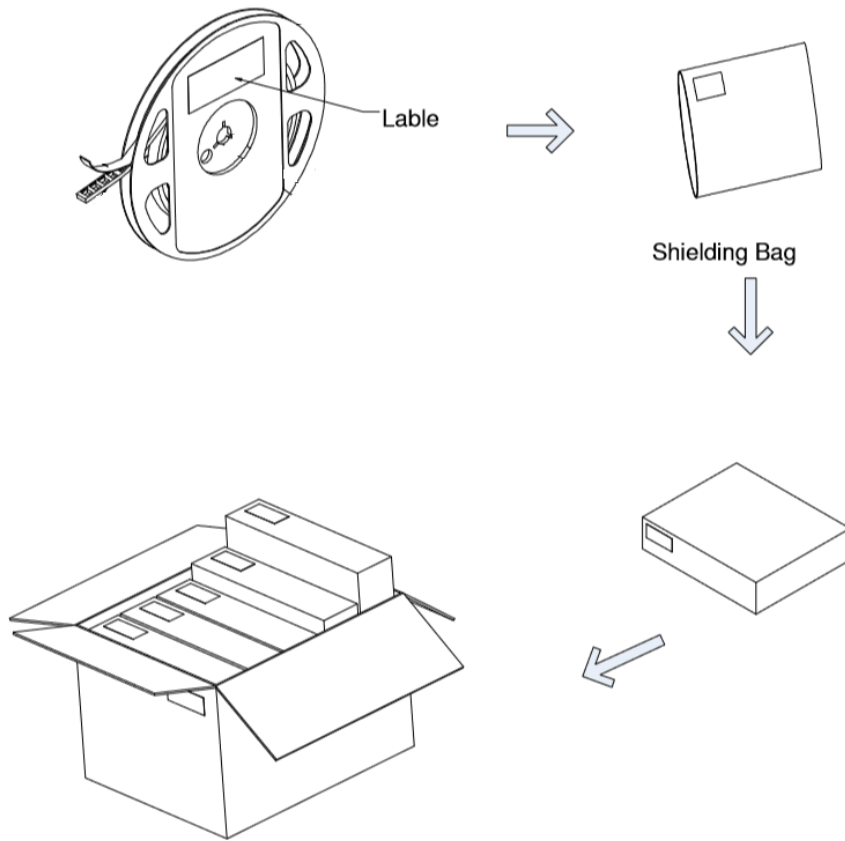
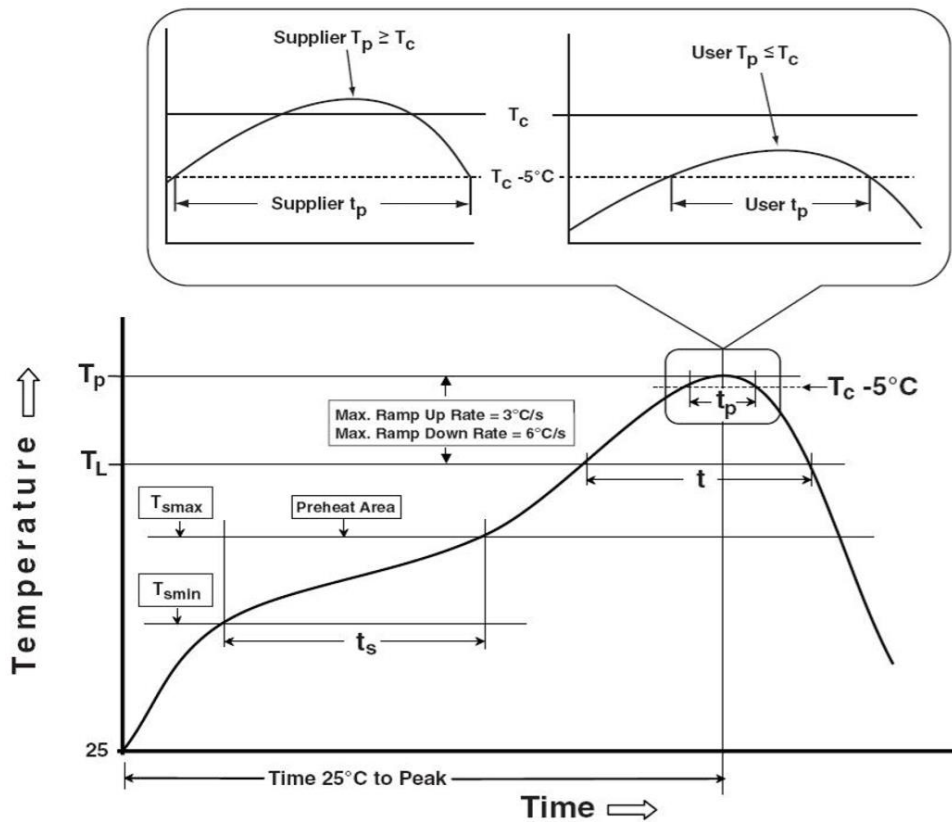


Table of Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak	100 °C	150 °C
Temperature min (T _{min})	150°C	200 °C
Temperature max (T _{max})	60-120 seconds	60-120 seconds
Time (T _{min} to T _{max}) (t _s)		
Average ramp-up rate (T _{max} to T _p)	3 °C/second max	3 °C/second max
Liquidous temperature (T _L)	183 °C	217 °C
Time at liquidous (t _L)	60-150 seconds	60-150 seconds
Peak package body temperature (T _p)*	230 °C ~235 °C	255 °C ~260 °C
Classification temperature (T _c)	235 °C	260 °C
Time (t _p) within 5 °C of the specified Classification temperature (T _c)	20 seconds	30 seconds
Average ramp-down rate (T _p to T _{max})	6 °C/second max	6 °C/second max
Time 25 °C to peak temperature	6 minutes max	8 minutes max

1. Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.
2. Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.



Precautions

1. Storage:

- Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to a minimum.
- Before opening the package, the product should be kept at 30°C or less and humidity less than 60% RH, and be used within a year.
- After opening the package, the product should be stored at 30°C or less and humidity less than 10%RH. It is recommended that the product be operated at the workshop condition of 30°C or less and humidity less than 60%RH.
- If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition: (70±5)°C for 24 hours.

2. Static Electricity:

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristics such as the forward voltage becoming lower, or the LEDs do not light at the low current, even not light.

All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wristbands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.

3. Vulcanization:

LED curing is due to sulfur being in brackets and the +1 price of silver in the chemical reaction generated Ag₂S in the process. It will lead to the capacity of reflecting of silver layer reducing, light color temperature drift and serious decline, seriously affecting the performance of the product. So we should take corresponding measures to avoid vulcanization, such as to avoid using sulphur volatile substances and keeping away from high sulphur content of the material.